DATA SHEET

74ALS645A/74ALS645A–1

Octal transceiver (3–State)

Product specification
IC05 Data Handbook

1991 Jun 03

Philips
Semiconductors

PHILIPS

Octal transceiver (3-State)

74ALS645A/74ALS645A-1

FEATURES

- Octal bidirectional bus interface
- 3-State buffer outputs sink 24mA and source 15mA
- Outputs are placed in high impedance state during power-off conditions
- The -1 version sinks 48mA I_{OL} within the +5% V_{CC} range

DESCRIPTION

The 74ALS645A is an octal transceiver featuring non-inverting 3-State bus compatible outputs in both transmit and receive directions. The device features an output enable ($\overline{OE}$) input for easy cascading and transmit/receive ($R/\overline{T}$) input for direction control.

The 74ALS645A-1 is the same as the 74ALS645A except that both ports sink 48mA within the ±5% V_{CC} range.

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS645A	7.0ns	34mA
74ALS645A-1	7.0ns	34mA

PIN CONFIGURATION

SF00198
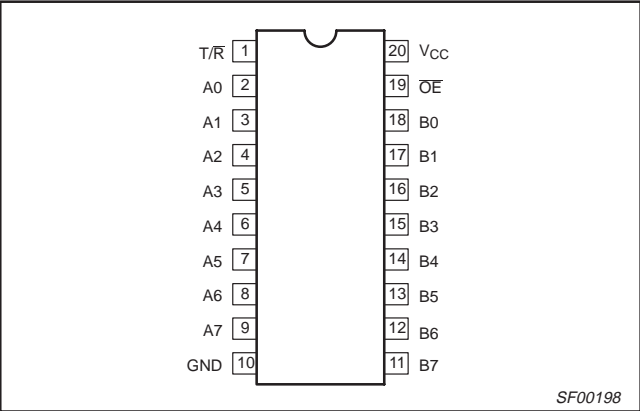
ORDERING INFORMATION

DESCRIPTION	ORDER CODE	DRAWING NUMBER
	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0°C$ to $+70°C$	
20-pin plastic DIP	74ALS645AN, 74ALS645A-1N	SOT146-1
20-pin plastic SOL	74ALS645AD, 744ALS645A-1D	SOT163-1

## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0 – A7, B0 – B7	Data inputs	1.0/1.0	20μA/0.1mA
$\overline{OE}$	Output Enable input (active-Low)	1.0/1.0	20μA/0.1mA
T/$\overline{R}$	Transmit/receive input	1.0/1.0	20μA/0.1mA
A0 – A7	A port outputs	750/240	15mA/24mA
B0 – B7	B port outputs	750/240	15mA/24mA
A0 – A7	A port outputs (-1 version)	750/480	15mA/48mA
B0 – B7	B port outputs (-1 version)	750/480	15mA/48mA

NOTE: One (1.0) ALS unit load is defined as: 20μA in the High state and 0.1mA in the Low state.
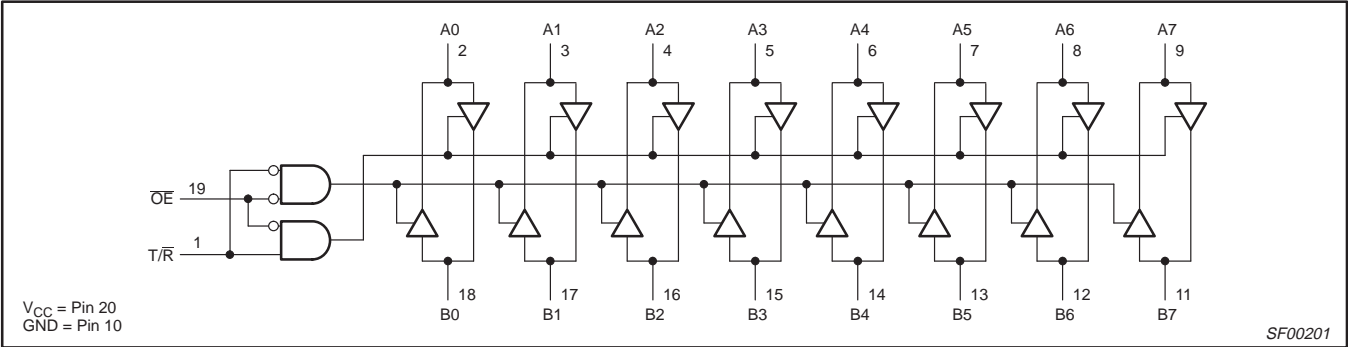
LOGIC SYMBOL

V_{CC} = Pin 20
GND = Pin 10

SF00199

IEC/IEEE SYMBOL

SC00097
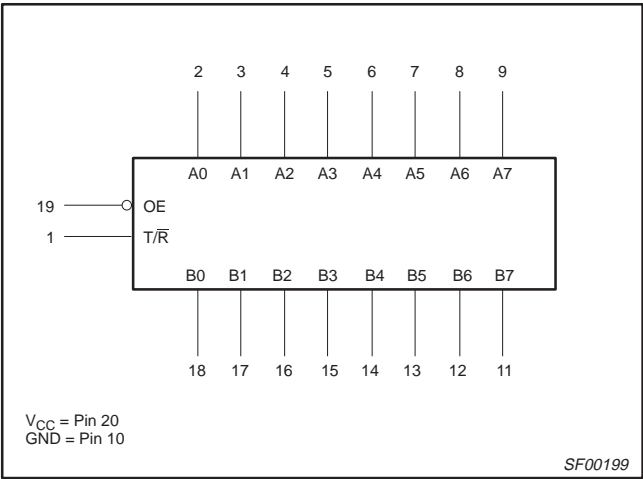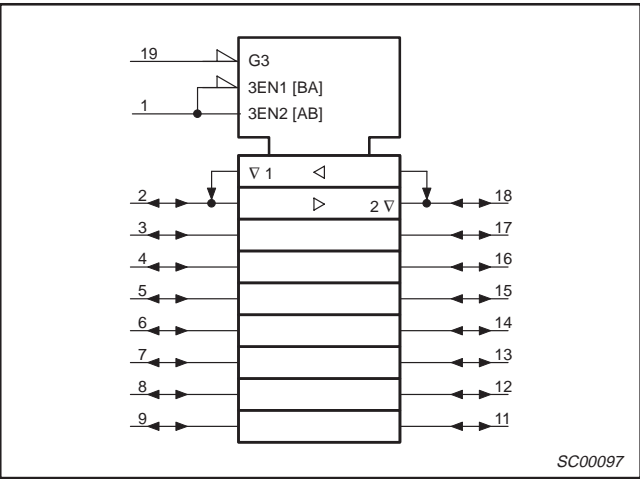
Octal transceiver (3-State)

74ALS645A/74ALS645A-1

LOGIC DIAGRAM

SF00201

FUNCTION TABLE

INPUTS		OUTPUTS
$\overline{OE}$	T/$\overline{R}$	
L	L	Bus B data to Bus A
L	H	Bus A data to Bus B
H	X	Z

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		−0.5 to +7.0	V
V_{IN}	Input voltage		−0.5 to +7.0	V
I_{IN}	Input current		−30 to +5	mA
V_{OUT}	Voltage applied to output in High output state		−0.5 to V_{CC}	V
I_{OUT}	Current applied to output in Low output state	All versions	48	mA
		-1 version	96	mA
T_{amb}	Operating free-air temperature range		0 to +70	°C
T_{stg}	Storage temperature range		−65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5.0	5.5	V
V_{IH}	High-level input voltage		2.0			V
V_{IL}	Low-level input voltage				0.8	V
I_{IK}	Input clamp current				−18	mA
I_{OH}	High-level output current				−15	mA
I_{OL}	Low-level output current	All versions			24	mA
		-1 version			48[1]	mA
T_{amb}	Operating free-air temperature range		0		+70	°C

NOTES:
1. The 48mA limit applies only under the condition of V_{CC} = 5.0V ± 5%.

Octal transceiver (3-State)

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS[1]		LIMITS			UNIT
					MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage		$V_{CC} \pm 10\%$, $V_{IL} = $ MAX, $V_{IH} = $ MIN	$I_{OH} = -0.4$mA	$V_{CC} - 2$			V
				$I_{OH} = -3$mA	2.4	3.2		V
			$V_{CC} = $ MIN, $V_{IL} = $ MAX, $V_{IH} = $ MIN	$I_{OH} = -15$mA	2.0			V
V_{OL}	Low-level output voltage	All versions	$V_{CC} = $ MIN, $V_{IL} = $ MAX, $V_{IH} = $ MIN	$I_{OL} = 12$mA		0.25	0.40	V
				$I_{OL} = 24$mA		0.35	0.50	V
		-1 version	$V_{CC} = 4.75$V, $V_{IL} = $ MAX, $V_{IH} = $ MIN	$I_{OL} = 48$mA		0.35	0.50	V
V_{IK}	Input clamp voltage		$V_{CC} = $ MIN, $I_I = I_{IK}$			−0.73	−1.5	V
I_I	Input current at maximum input voltage	$\overline{OE}$ or T/$\overline{R}$	$V_{CC} = $ MAX, $V_I = 7.0$V				0.1	mA
		A or B ports	$V_{CC} = $ MAX, $V_I = 5.5$V				0.1	mA
I_{IH}	High-level input current[3]		$V_{CC} = $ MAX, $V_I = 2.7$V				20	μA
I_{IL}	Low-level input current[3]		$V_{CC} = $ MAX, $V_I = 0.4$V				−0.1	mA
I_O	Output current[4]		$V_{CC} = $ MAX, $V_O = 2.25$V		−30		−112	mA
I_{CC}	Supply current (total)	I_{CCH}	$V_{CC} = $ MAX			28	45	mA
		I_{CCL}				40	55	mA
		I_{CCZ}				44	58	mA

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at $V_{CC} = 5$V, $T_{amb} = 25°$C.
3. For I/O ports, the parameter I_{IH} and I_{IL} include the off-state current.
4. The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

AC ELECTRICAL CHARACTERISTICS

| SYMBOL	PARAMETER	TEST CONDITION	LIMITS $T_{amb} = 0°$C to $+70°$C $V_{CC} = +5.0$V $\pm$ 10% $C_L = 50$pF, $R_L = 500\Omega$		UNIT
			MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay An to Bn, Bn to An	Waveform 1	2.0 2.0	10.0 10.0	ns
t_{PZH} t_{PZL}	Output enable time to High or Low level	Waveform 2 Waveform 3	3.0 3.0	20.0 20.0	ns
t_{PHZ} t_{PLZ}	Output disable time from High or Low level	Waveform 2 Waveform 3	2.0 4.0	10.0 15.0	ns

AC WAVEFORMS

For all waveforms, $V_M = 1.3V$.
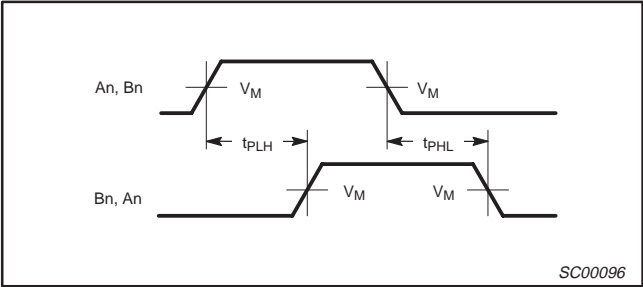
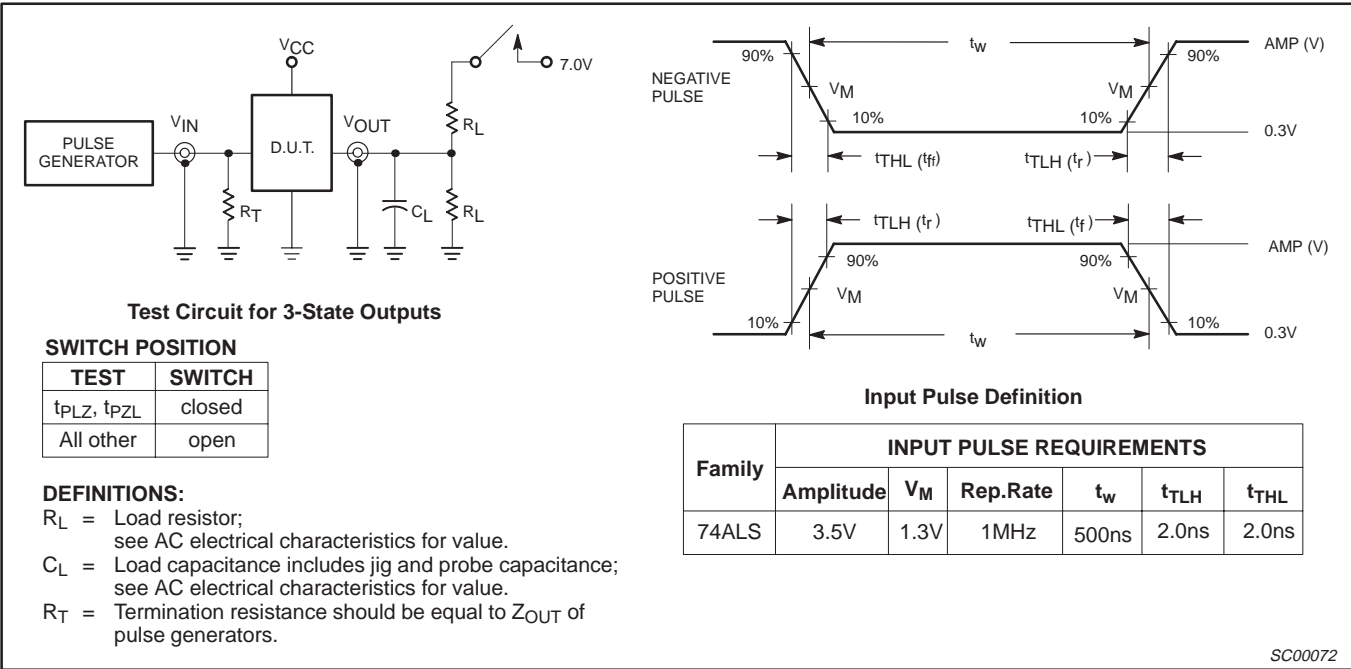**Waveform 1.   Propagation Delay for Non-inverting Outputs**
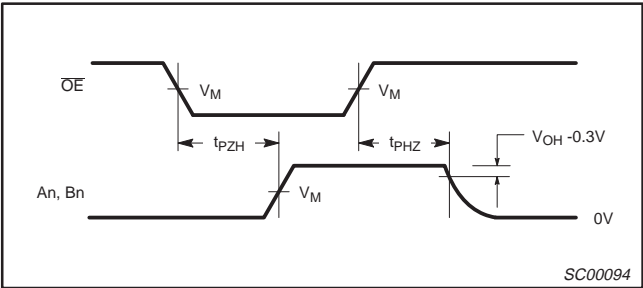
Waveform 2.   3-State Output Enable Time to High Level and Output Disable Time from High Level
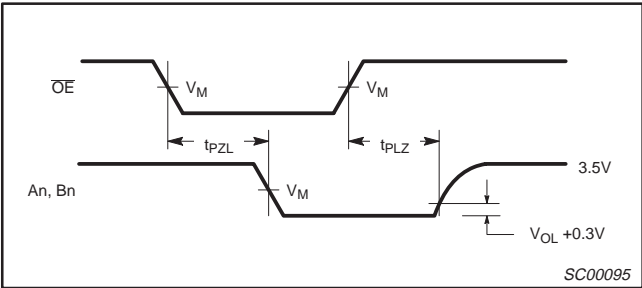
Waveform 3.   3-State Output Enable Time to Low Level and Output Disable Time from Low Level

TEST CIRCUIT AND WAVEFORMS

Test Circuit for 3-State Outputs

SWITCH POSITION

TEST	SWITCH
t_{PLZ}, t_{PZL}	closed
All other	open

DEFINITIONS:

R_L = Load resistor;
see AC electrical characteristics for value.

C_L = Load capacitance includes jig and probe capacitance;
see AC electrical characteristics for value.

R_T = Termination resistance should be equal to Z_{OUT} of
pulse generators.

Input Pulse Definition

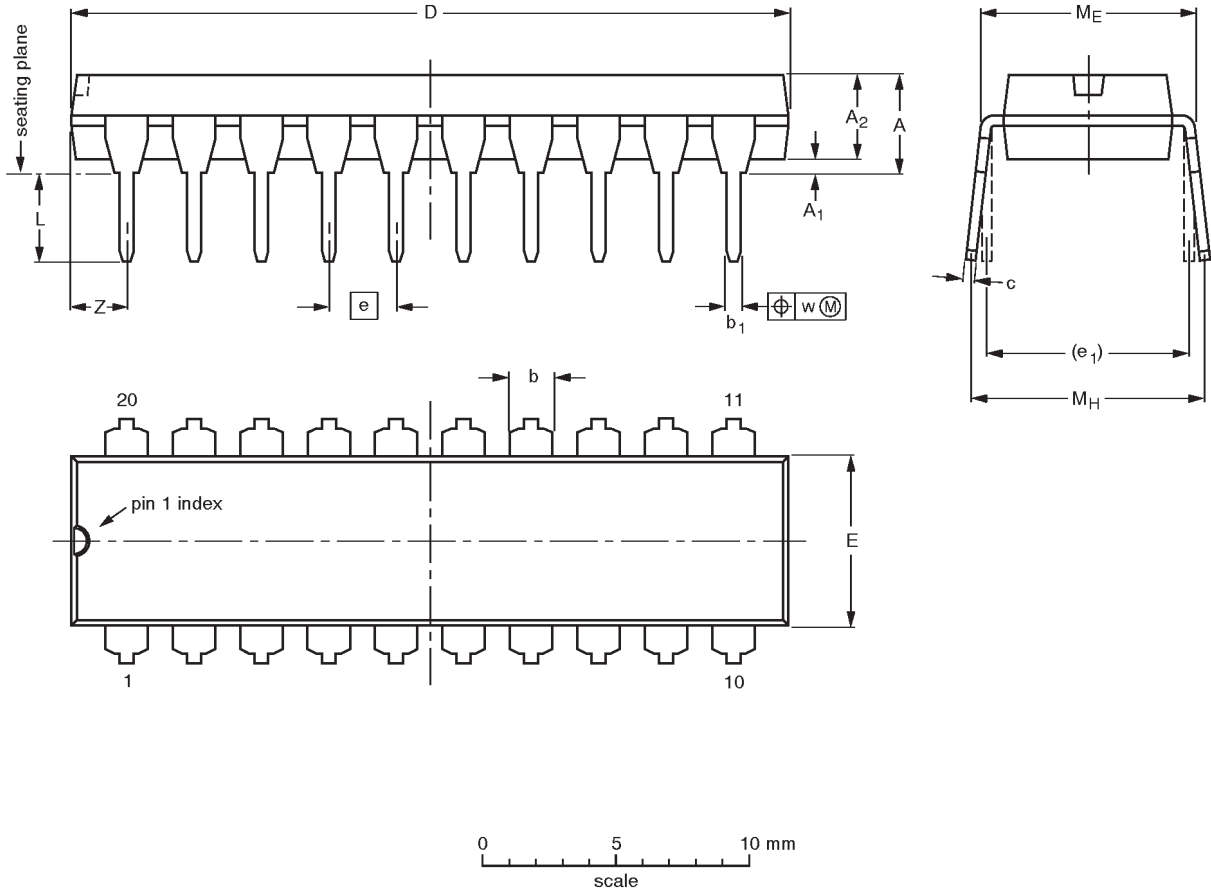| Family	INPUT PULSE REQUIREMENTS					
	Amplitude	V_M	Rep.Rate	t_w	t_{TLH}	t_{THL}
74ALS	3.5V	1.3V	1MHz	500ns	2.0ns	2.0ns

Octal transceiver (3–State)

74ALS645A/74ALS645A–1

DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1

0   5   10 mm
scale

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁ min.	A₂ max.	b	b₁	c	D [1]	E [1]	e	e₁	L	M_E	M_H	w	Z [1] max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

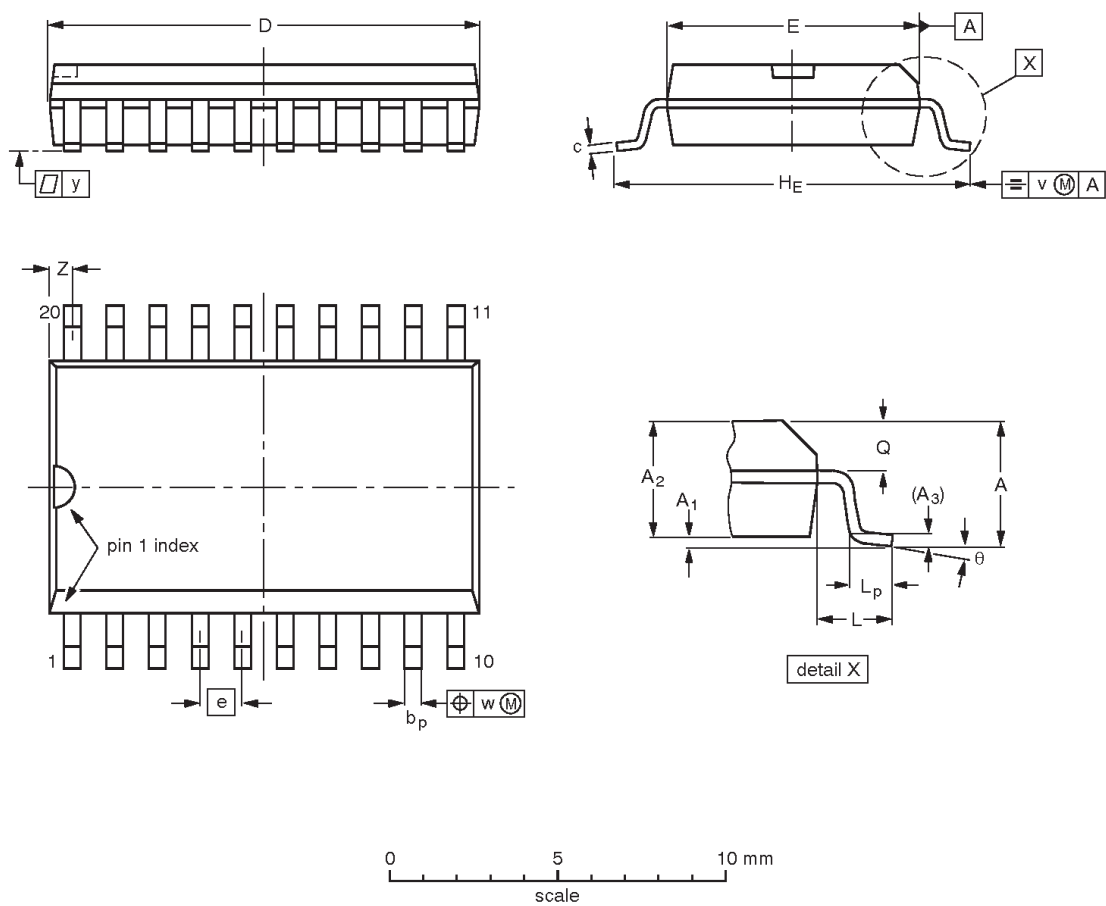1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT146-1			SC603			~~92-11-17~~ 95-05-24

Octal transceiver (3–State)

74ALS645A/74ALS645A–1

SO20:   plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

pin 1 index

detail X

scale

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D (1)	E (1)	e	Hₑ	L	Lₚ	Q	v	w	y	Z (1)	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				~~92-11-17~~ 95-01-24

Octal transceiver (3–State)

74ALS645A/74ALS645A–1

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1]   Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

print code   Date of release: 05-96

Document order number: 9397-750-03308

Let's make things better.

Philips
Semiconductors

PHILIPS